

MTTL/SECT/27/2025-26

Date: August 26, 2026

The Secretary, Listing Department, BSE Ltd., Phiroze Jeejeebhoy Towers, Dalal Street, Fort, Mumbai-400001. Scrip Code: 526263	The Manager, Listing Department, National Stock Exchange of India Limited, Exchange Plaza, 5th Floor, Plot No. C/1, G Block, Bandra Kurla Complex, Bandra (E), Mumbai-400051. Symbol: MOLDTECH - EQ
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Sir/Madam,

Sub: Outcome of the Board Meeting held on August 26, 2026.

This is to inform you that the Board of Directors (Board) of the Company at its meeting held today i.e. Wednesday, August 26, 2026, inter-alia, transacted the following business (es):

1. Issuance of Bonus Shares:

Issuance of Bonus equity shares in the ratio 1:1 i.e. 1 (One) equity shares of Rs. 2/- each for every 1 (One) full paid-up equity share of Rs. 2/- each held by the Shareholders of the Company as on the Record Date, subject to the approval of Shareholders. The Company will inform the "Record Date" for determining the entitlement of the Shareholders to receive Bonus Shares in due course.

2. Recommending Final Dividend:

Recommending a final dividend of ₹ 2.00/- per equity share for the financial year March 31, 2026 on Equity Shares of face value of ₹ 2/- each.

This Dividend of ₹ 2.00/- per equity share is subject to the approval of Members at the ensuing Annual General Meeting which will be held on September 21, 2026. The dividend if declared will be paid (subject to deduction/withholding of applicable taxes) within the timelines prescribed under the law.

The Record date for determining the entitlement of the Shareholders to the final dividend is September 14, 2026.

3. Fixing of Annual General Meeting:

Approved the convening of 42nd Annual General Meeting of the Company on Monday, September 21, 2026 through video conference/ Other Audio Visual Means.

4. Book Closure:

The Register of Members and the Share Transfer Books of the Company will be closed for the purpose of the 42nd Annual General Meeting (AGM) and determining the entitlement of the Members for the final dividend of the Company from Tuesday, September 15, 2026 to Monday, September 21, 2026 (both days inclusive).



Further, the details as required under Regulation 30 of the Securities and Exchange Board of India (Listing Obligations and Disclosure Requirements) Regulations, 2015 of the SEBI Circular SEBI/HO/CFD/PoD2/CIR/P/0155 dated 11th November 2024 and SEBI Master Circular dated January 30, 2026 as 'Annexure I' are enclosed as **Annexure-A**.

The meeting of Board of directors commenced at 01:30 PM (IST) and concluded at 02:55 PM (IST).

This is for your kind information and record.

Thanking you,
For Mold-Tek Technologies Limited

Prateek Kumar Tiwari
Company Secretary & Compliance Officer

Encl: A/a

Mold-Tek Technologies Limited

Regd. Off.: Plot No.700, Door No.8-2-293/82/A/700, Road No.36, Jubilee Hills, Hyderabad – 500033, Telangana, India
Phone: +91-40-40300300/01/02/03/04, Fax: +91-40-40300328, E-mail Id: cstech@moldtekindia.com
Website: www.moldtekindia.com CIN No: L25200TG1985PLC005631

Annexure - A

Disclosure of Information pursuant to Regulation 30 of the SEBI Listing Regulations read with SEBI circular No. SEBI/HO/CFD/PoD2/CIR/P/0155 November 11, 2024 and SEBI Master Circular dated January 30, 2026.

Sr. No.	Particulars	Details
1.	Type of securities proposed to be issued (viz. equity shares, convertibles etc.);	Equity Shares
2.	Type of issuance	Bonus Issue
3.	Total number of securities proposed to be issued or total amount for which the securities will be issued (approximately)	2,88,05,118 Equity Shares of Rs. 2/- each amounting to Rs. 5,76,10,236/- (Rupees Five Crores Seventy Six Lacs Ten Thousand Two Hundred Thirty Six Only).
4.	Whether bonus out of free reserves, I created out of profits or share premium account	The Bonus equity Shares will be issued out of Free Reserve of the Company available as on March 31, 2026.
5.	Bonus Ratio	1:1 i.e. 1 (One) Bonus Equity Share of Rs. 2/- each for every 1 (One) fully paid-up equity shares of Rs. 2/- each held as on the record date.
6.	Whether bonus is out of free reserves created out of profits or share premium account;	Yes. Bonus Equity Shares will be issued from free reserve, Retained Earnings and Securities Premium and other eligible reserves available with Company.
7.	Details of share capital - pre and post bonus issue	Pre-Bonus issue Paid up Share Capital: Rs. 5,76,10,236/- divided into 2,88,05,118 Equity Shares of face value of Rs. 2/- each and Post Bonus Issue: Rs. 11,52,20,472/- divided into 5,76,10,236 Equity Shares of face value of Rs. 2/- each.
8.	Free Reserves and/or Share Premium required for implementing the bonus issue;	Rs. 5,76,10,236/- (Rupees Five Crores Seventy-Six Lacs Ten Thousand Two Hundred Thirty-Six Only) will be utilized from Free Reserve/Retained Earning of Company
9.	Free Reserves and/or Share Premium available for capitalization and the date as on which such balance is available;	Rs. 1,15,00,36,940 available in Free Reserve/Retained Earning of Company as on 31 st March, 2026
10.	whether the aforesaid figures are audited	No
11.	estimated date by which such bonus shares would be credited/dispatched	The Bonus issue will be implemented within 2 months from the date of Board Meeting.

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ISO 9001:2008
BUREAU VERITAS
Certification



MOLD·TEK

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